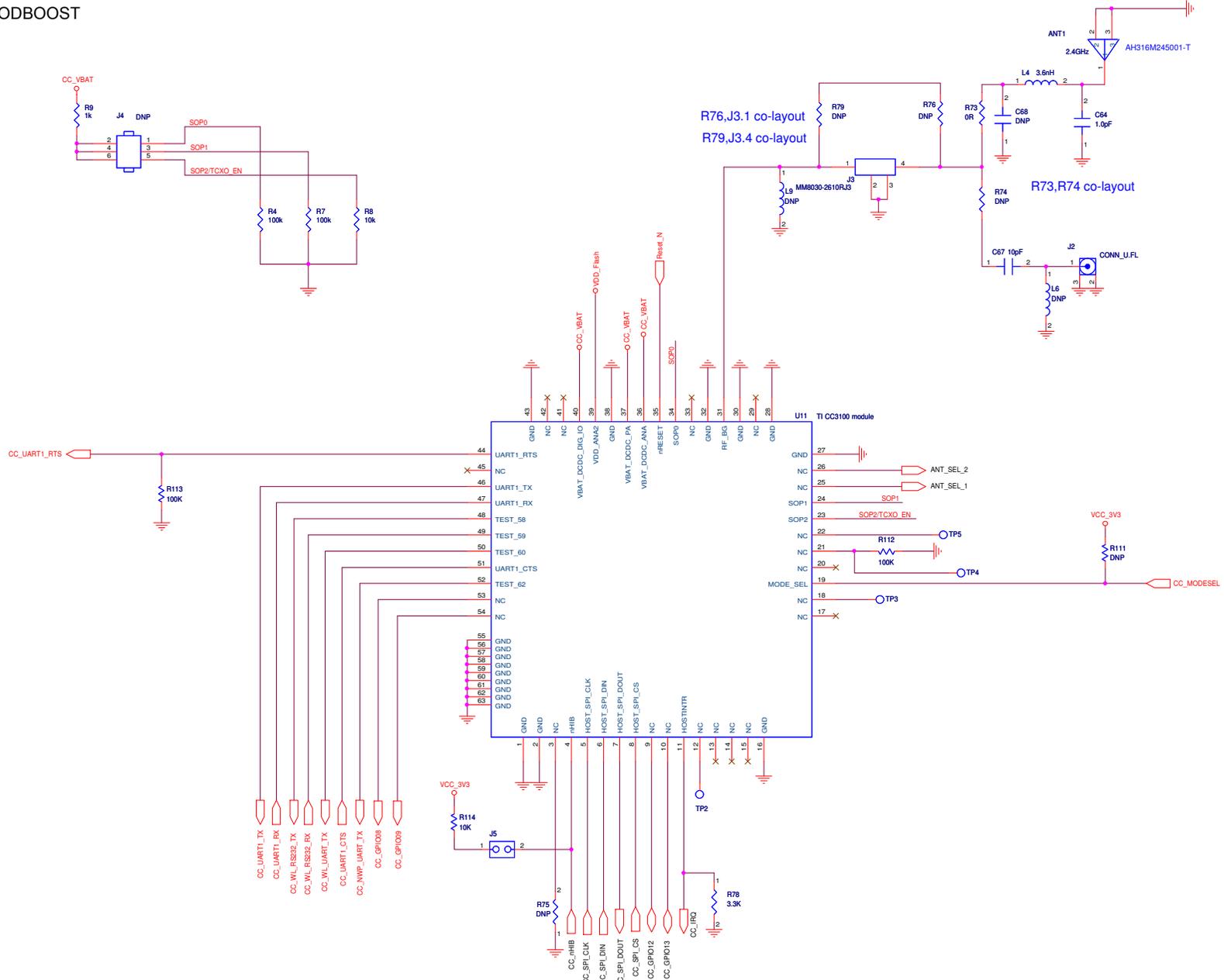
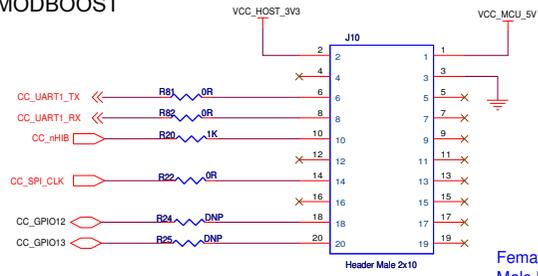


TIDC-CC3100MODBOOST

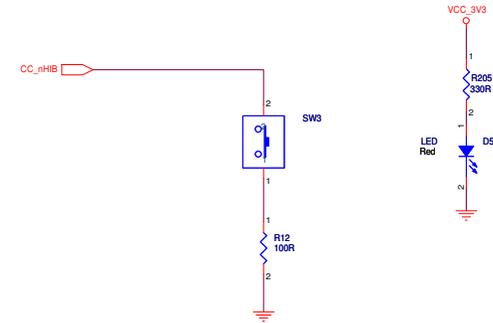
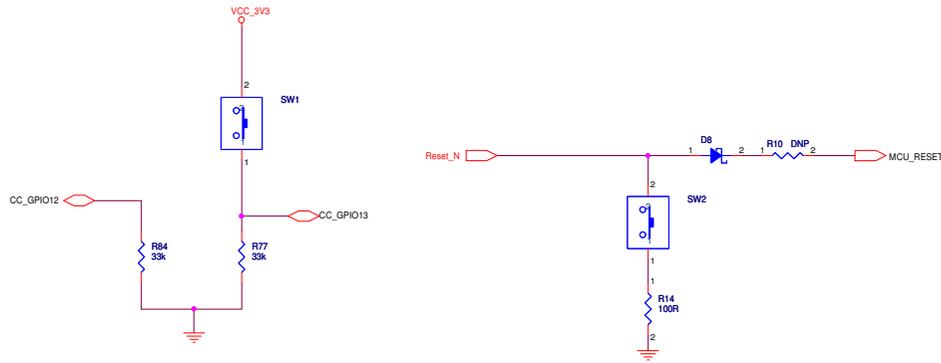


Host platform interface

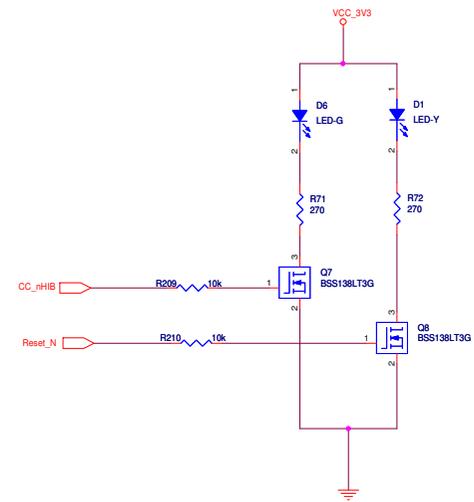
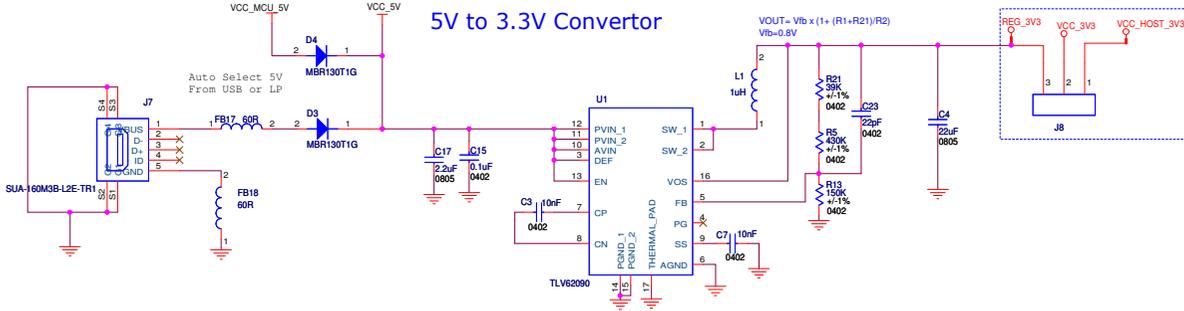
TIDC-CC3100MODBOOST



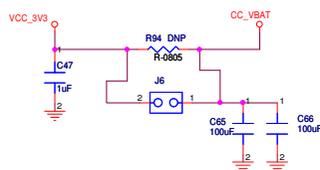
Female headers on BP on bottom side
Male headers on Launch Pad on top side



Jumper to choose 3.3V between 5V to 3.3V Regulator and LP



TP1
Test point for GND probe



Title		
CC3100 EVB Boost Pack		
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C	Host Interface	2.5
Date:	Wednesday, August 20, 2014	Sheet 2 of 2

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